

12500 TI Boulevard, MS 8640, Dallas, Texas 75243

# PCN# 20141104001 ISO7241C Data Sheet Data Sheet Change Notification

Date: 11/20/2014 To: Newark/Farnell PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Manager (<u>PCN ww admin team@list.ti.com</u>).

Sincerely,

PCN Team SC Business Services Phone: +1(214) 480-6037 Fax: +1(214) 480-6659

### 20141104001 Attachment: 1

# **Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

#### DEVICE

ISO7241CDW

#### **CUSTOMER PART NUMBER**

null

Technical details of this Product Change follow on the next page(s).

PCN Number:		20141104001						<b>PCN Date:</b> 11/20/2014			
Title: ISO7241C Da			ata Sheet								
Custome	Customer Contact: PCN Manage		Phone:		+1(214)480-6037		Dept:	Dept: Quality Service			
Proposed 1 <sup>st</sup> Ship Da		te:								•	
Change 1	ype:										
Assembly Site					Design			Wafer Bump Site		o Site	
Assembly Process					Data Sheet			Wafer	Wafer Bump Material		
Assembly Materials			5		Part number change				Wafer Bump Process		
Mechanical Specifica					Test Site				Wafer Fab Site		
Packing/Shipping/Labeling			ling	Test Process				Wafer Fab Materials			
<u> </u>								Wafer	Wafer Fab Process		
					PCN I	Details					
	<b>Description of Change:</b> The product datasheet(s) for ISO7241C have been updated as summarized in the following								- II		
		(S) TO	r ISO/2	410	_ nave be	en updated as s	umm	narized ir	i the i	rollowing	
change hi	story.										
TEVAS											
ISO7240CF, ISO7240C, ISO7240M											
ISO7241C, ISO7241M, ISO7242C, ISO7242M											
SLLS868P – SEPTEMBER 2007 – REVISED OCTOBER 2014 www.ti.com											
Changes from Revision O (November 2012) to Revision P Page											
Added Pin Configuration and Functions section, Handling Rating table, Feature Description section, Device											
Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout											
-	section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information										
section											
Changed ISO7241C minimum supply from 2.8 V to 3.15 V											
The datas	heet number	will I	be chan	ging	].						
Device F				Change From: Change To:				nge To:			
IS07241	С		SL	LS8680 SLLS				S868P	868P		
These changes may be reviewed at the datasheet links provided.											
http://www.ti.com/lit/gpn/iso7241c											
Reason for Change:											
To more accurately reflect device characteristics.											
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):											
Electrical specification performance changes as indicated above.											
Changes to product identification resulting from this PCN:											
None.											
<b>Product</b>	Affected:										
IS07241	CDW	IS	072410	DW	DWG4 ISO7241CDWR ISO7241CDWRG4						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
Japan	PCNJapanContact@list.ti.com